

TX-4575W45FSA3-NU3BJ-01

PRODUCT SPECIFICATION

Features:

- ◆Excellent transiting heat from LED chip operating under 5000mA.
- ◆Ceramic eutectic package allows it to have minimal internal stress and excellent thermal path.
- ◆Flip chip coated with package, the output of lumen is stable.
- ◆High luminous output.
- ◆Encapsulated materials are environmentally certified and meet environmental requirements.

Chip Material:

- ◆GaN

Emitting Color:

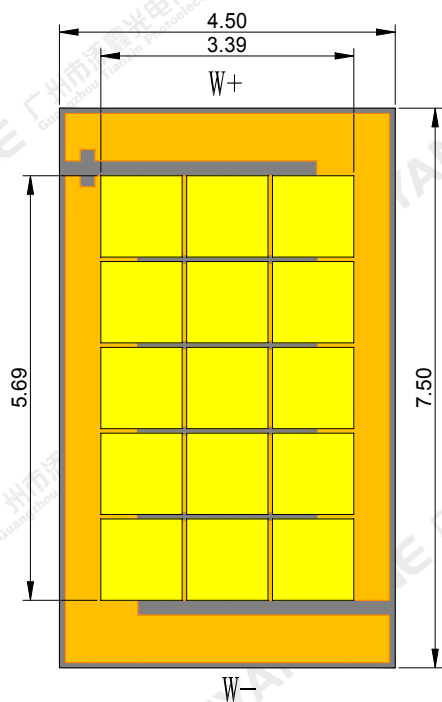
- ◆Cold white

Applications:

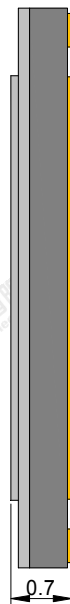
- ◆Automobile lighting

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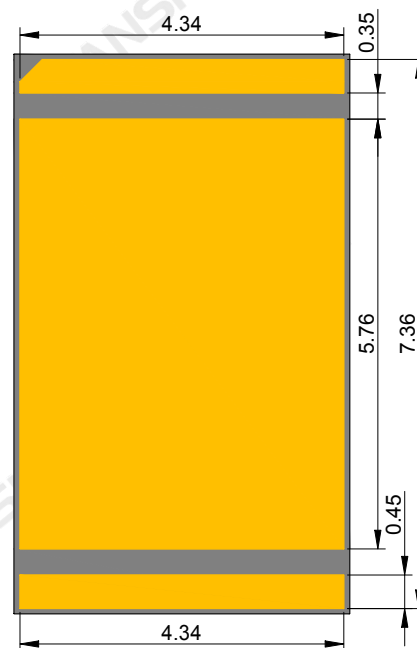
Package Dimensions:



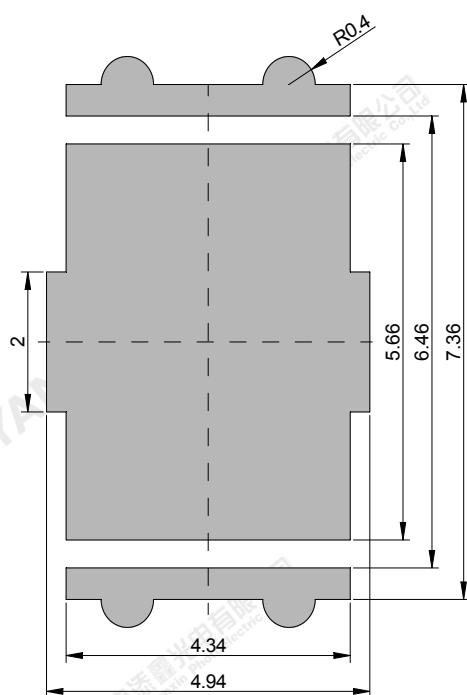
Top view



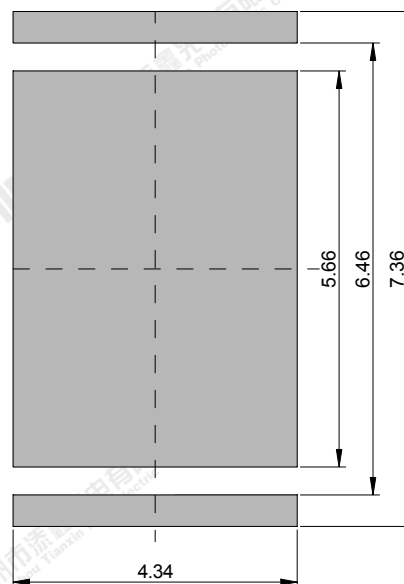
Side view



Bottom view



Recommended solder pad



recommended stencil pattern

Notes:

- 1.All dimensions are in millimeters .
- 2.Tolerances unless otherwise mentioned are $\pm 0.1\text{mm}$.

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Absolute Maximum Ratings (Tc=25℃)

Parameter	Symbol	Ratings	Unit
Forward Current	IF	5000	mA
Reverse Voltage	VR	Not designed for reverse operation	V
Power Dissipation	PD	50	W
Junction Temperature	Tj	150	℃
Electrostatic Discharge Threshold (ESD)	ESD	2000	V
Storage Temperature	Tstg	-40~+70	℃
Operation Temperature	Topr	-30~+125	

Notes:

- 1.Specifications are subject to change without notice.
- 2.The data on this specification is for reference only and the actual data is in accordance with the acknowledgment.
- 3.Precautions for ESD:
STATIC SHIELD Electricity and surge damages the LED. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

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Electrical Optical Characteristics (Tc=25°C)

Parameter	Symbol	Condition	Emitting color	Min.	Typ.	Max.	Units
Luminous Flux	Φ_v	If=5000mA	W	4300	4700	5100	lm
Forward Voltage	V_f		W	9.2	9.7	10.0	V
Correlated Colour Temperature	CCT	If=1000mA	W	5000	5500	6000	K
Viewing Angle at 50 % IV	$2\theta_{1/2}$	—	W	—	120	—	Deg
Reverse Current	I_R	—	W	—	—	—	μA
Thermal Resistance Junction to Case	$R\theta_{J-C}$	If=5000mA	—	—	0.52	—	K/W
Temperature Coefficient of Voltage	$V\Delta F/T$		—	—	-2.8	—	mV/°C

White light Color coordinate filing (IF=1000mA)

Region	CCT Range		X1	Y1	X2	Y2	X3	Y3	X4	Y4
	Min	Max								
H11	5000K	5300K	0.3467	0.3741	0.3376	0.3644	0.3381	0.3793	0.3475	0.3896
G12	5300K	5700K	0.3374	0.3592	0.3276	0.3470	0.3273	0.3620	0.3380	0.3757
G10	5700K	6000K	0.3277	0.3432	0.3218	0.3369	0.3207	0.3501	0.3274	0.3570

Notes:

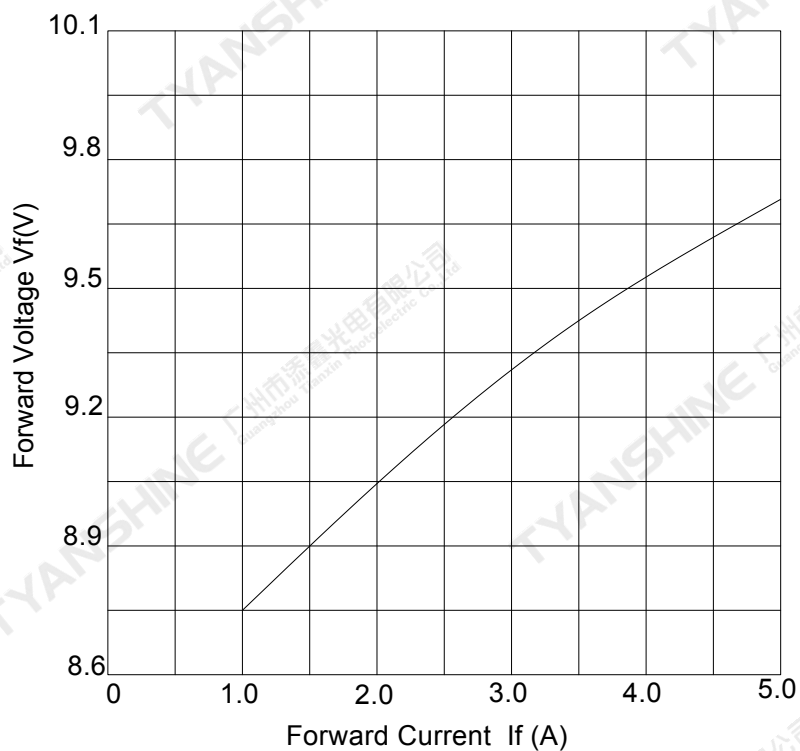
- 1.Luminous intensity is measured with a light sensor and filter combination that approximates the CIE eye-response curve.
2. $\theta_{1/2}$ is the off-axis angle at which the luminous intensity is half the axial luminous intensity.
- 3.The dominant wavelength (λ_d) is derived from the CIE chromaticity diagram and represents the single wavelength which defines the color of the device.
- 4.Luminous flux measurement tolerance:±15%.
- 5.Forward voltage measurement tolerance:±0.15V.

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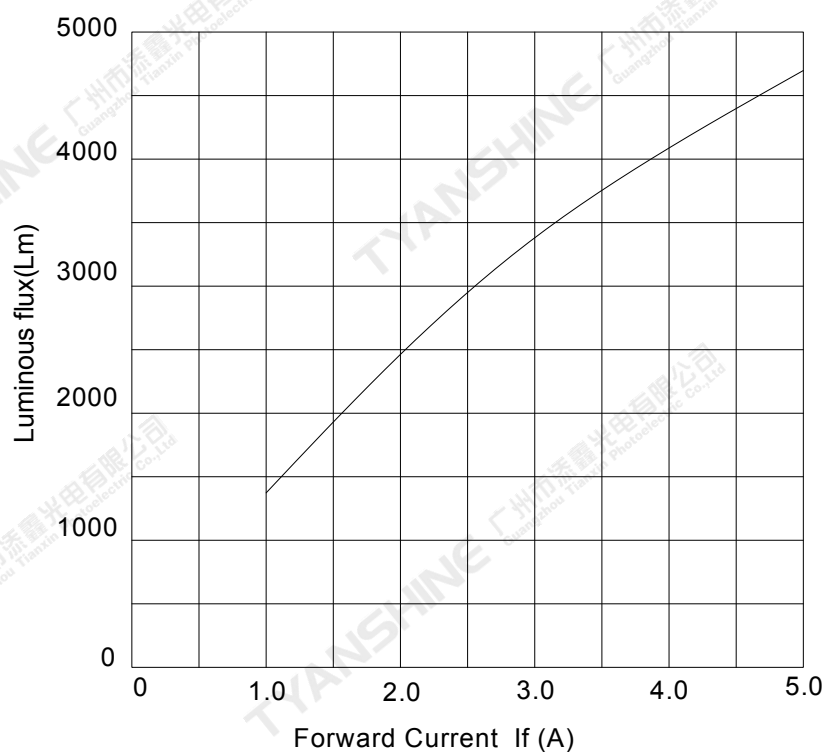
Typical Electrical/Optical Characteristics Curves

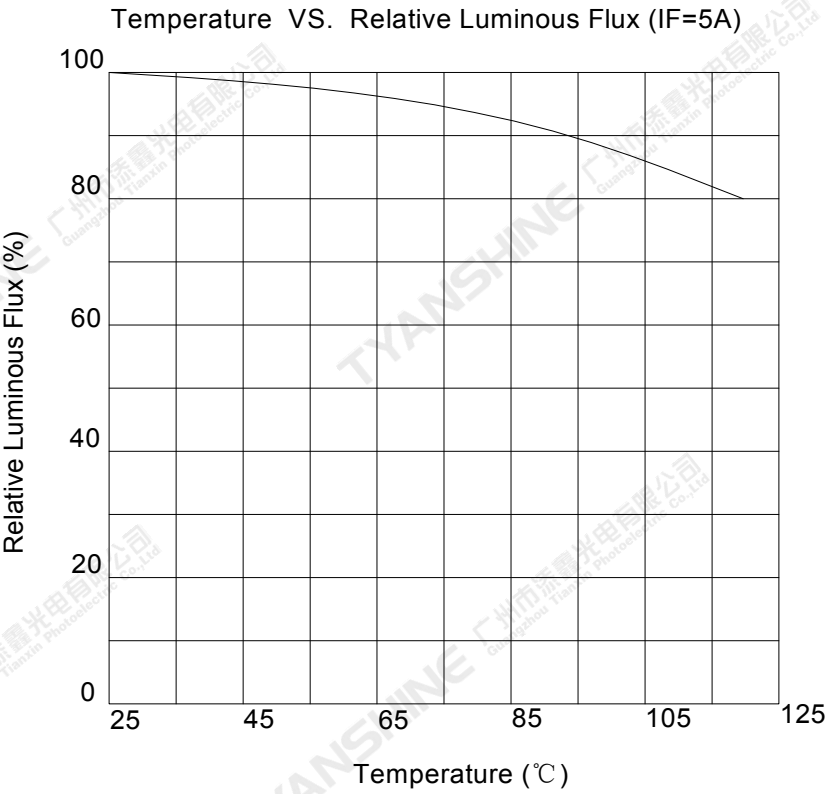
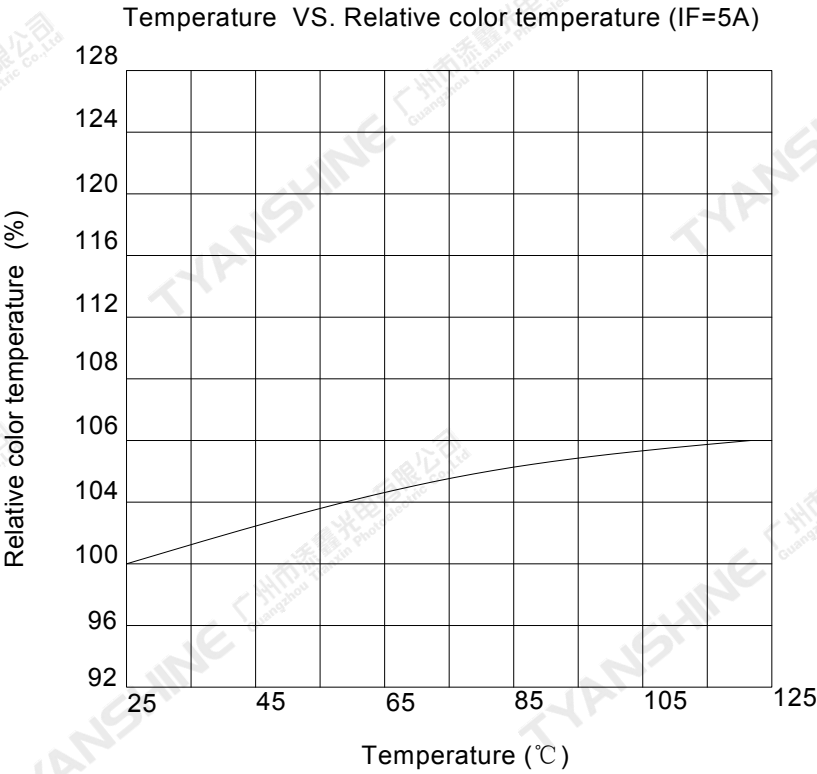
(25°C Ambient Temperature Unless Otherwise Noted)

Forward Current VS. Forward Voltage

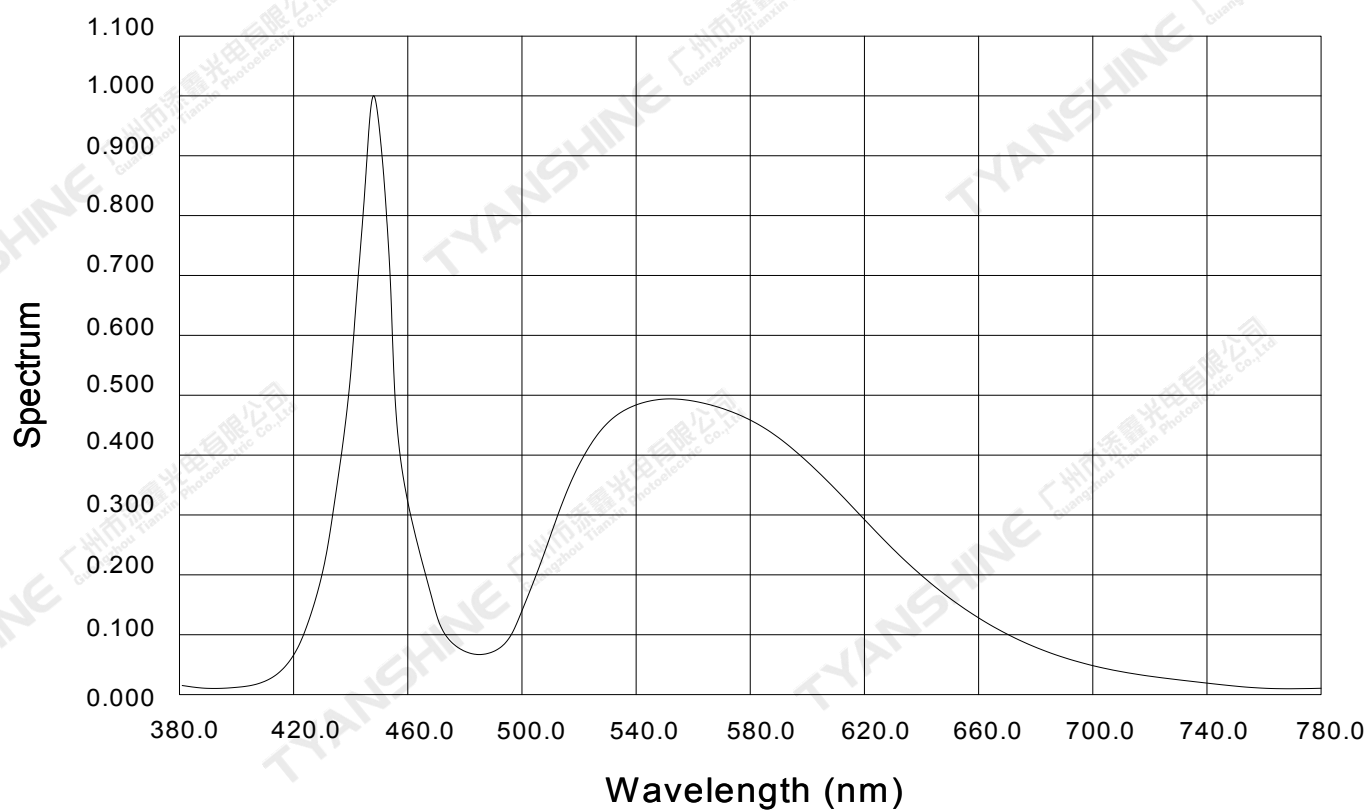


Forward Current VS. Luminous flux

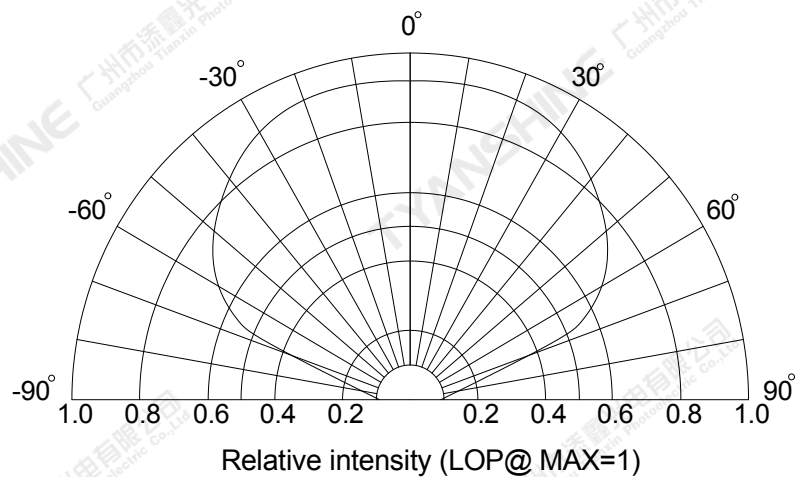




Relative Spectral Distribution



Beam Pattern

**Notes:**

1. 2θ 1/2 is the off axis angle from lamp centerline where the luminous intensity is 1/2 of the peak value.
2. View angle tolerance is ± 5°.

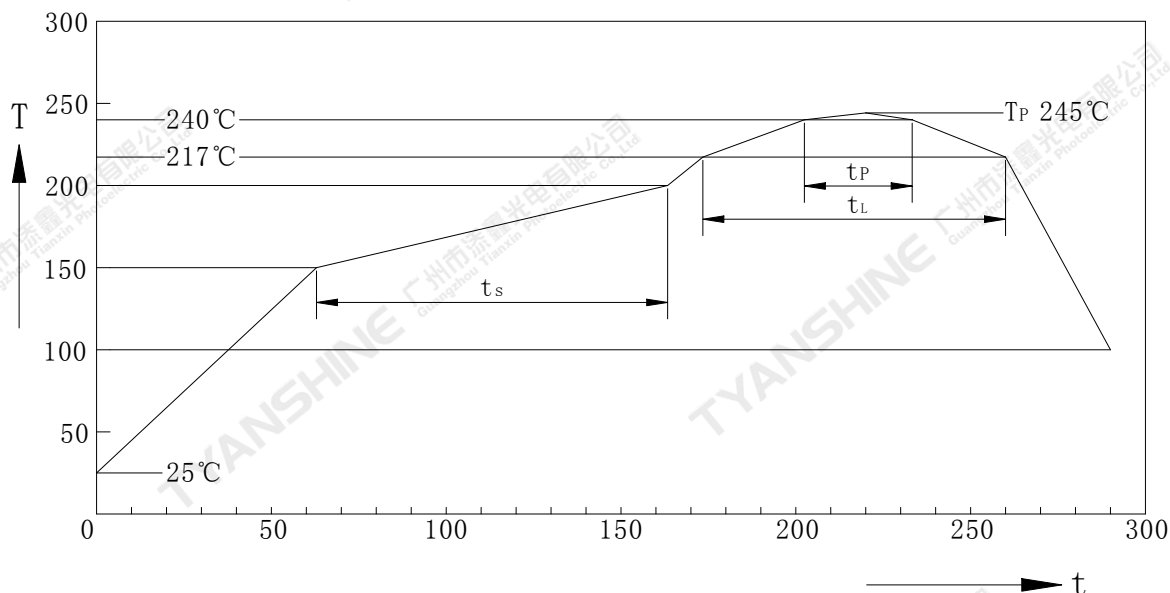
Usage Precautions

Storage Environment Condition

Temperature: 5°C ~ 30°C (41°F ~ 86°F)

Humidity: 60% RH Max.

Soldering Condition



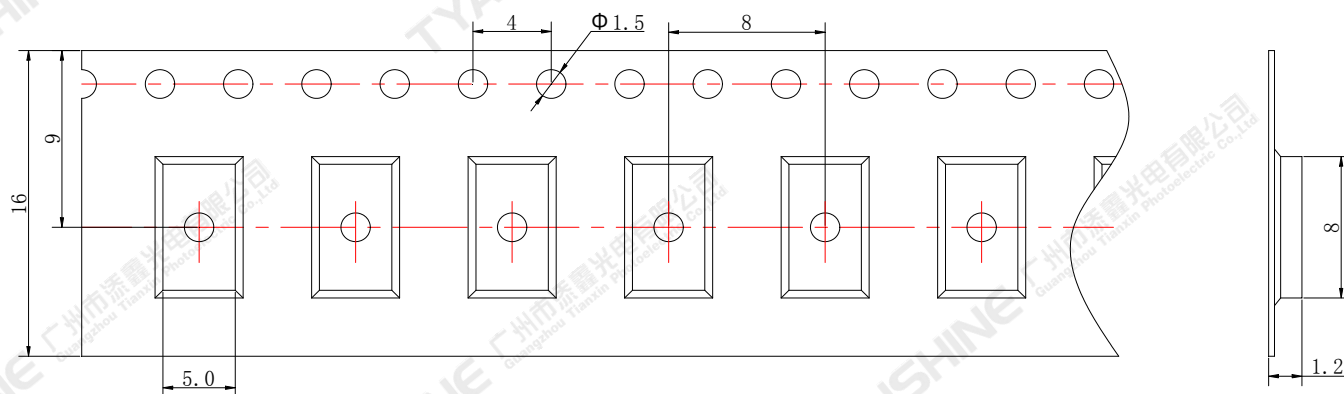
Profil-Charakteristik Profile Feature	Symbol	Pb-Free(SnAgCu)Assembly			Einheit Unit
		Minimum	Recommendation	Maximum	
Ramp-up Rate to Preheat 25°C to 150°C	-	-	2	3	K/s
Time t_s T_{Smin} to T_{Smax}	t_s	60	100	120	s
Ramp-up Rate to Peak T_{Smax} to T_P	-	-	2	3	K/s
Liquidus Temperature	T_L	217			°C
Time above Liquidus temperature	t_L	-	80	100	s
Peak Temperature	T_P	-	245	260	°C
Time within 5°C of the specified peak temperature $T_P - 5$ K	t_P	10	20	30	s
Ramp-down Rate T_P to 100°C	-	-	3	6	K/s
Time 25°C to T_P	-	-	-	480	-

Note:

All temperatures refer to topside of the package, measured on the package body surface.

Dimensions For Cannulation And Packaging

Quantity: 1000PCS



Notes:

1. All dimensions are in millimeters.
2. Tolerances are ± 2.0 mm unless otherwise noted.
3. The products are packaged together with silica gel, Transport, not to the weight of welding LED light-emitting area, As a result of the weight of LED light-emitting zone in the quality of, Irresponsible of the Company.